Welcome!
Texas Instruments New Product Update

- This webinar will be recorded and available at www.ti.com/npu
- Phone lines are muted
- Please post questions in the chat or contact your TI sales contact or field applications engineer

HOW THE IoT HAS EVOLVED TO MAKE WAY FOR MATTER

New Product Update

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Product Systems Engineer

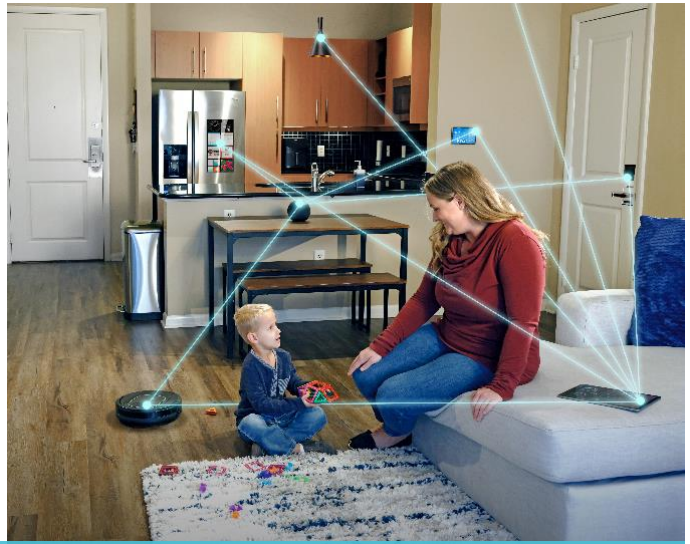
Introducing the new Matter protocol

matter

The Foundation for Connected Things

One protocol to connect compatible devices and systems with one another. Smart home devices should be secure, reliable, and seamless to use. And with Matter, they are.

Download Matter Specification



Matter is a royalty-free protocol developed by the **Connectivity Standards Alliance** that runs on top of Thread and Wi-Fi® and uses *Bluetooth*® Low Energy for commissioning.

Matter is a standard application interface that allows devices from different **ecosystems** to communicate, even if they are manufactured by different brands.

1973

Wi Fi CERTIFIED

1997

zigbee

1998

Bluetooth®

1998

THREAD

2014

Why Matter is important

Interoperable | Matter enabled devices works seamlessly with Apple, Amazon, Google, Samsung, major silicon vendors, and end product. No longer locked into a specific ecosystem. Matter specification developed over 3-years.

Technology | Leverages standardized internet protocol with Wi-Fi or Thread protocol. Open source code on github.

Security | Matter provides consumers with verification for the authenticity and security of Matter-certified devices.

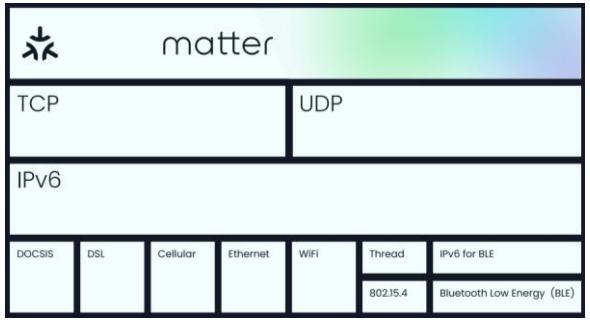
Ease-of-use | Commissioning your Matter-certified products via smartphones using Wi-Fi or Bluetooth LE technology. Then switches to use IP based protocol like Wi-Fi or Thread.

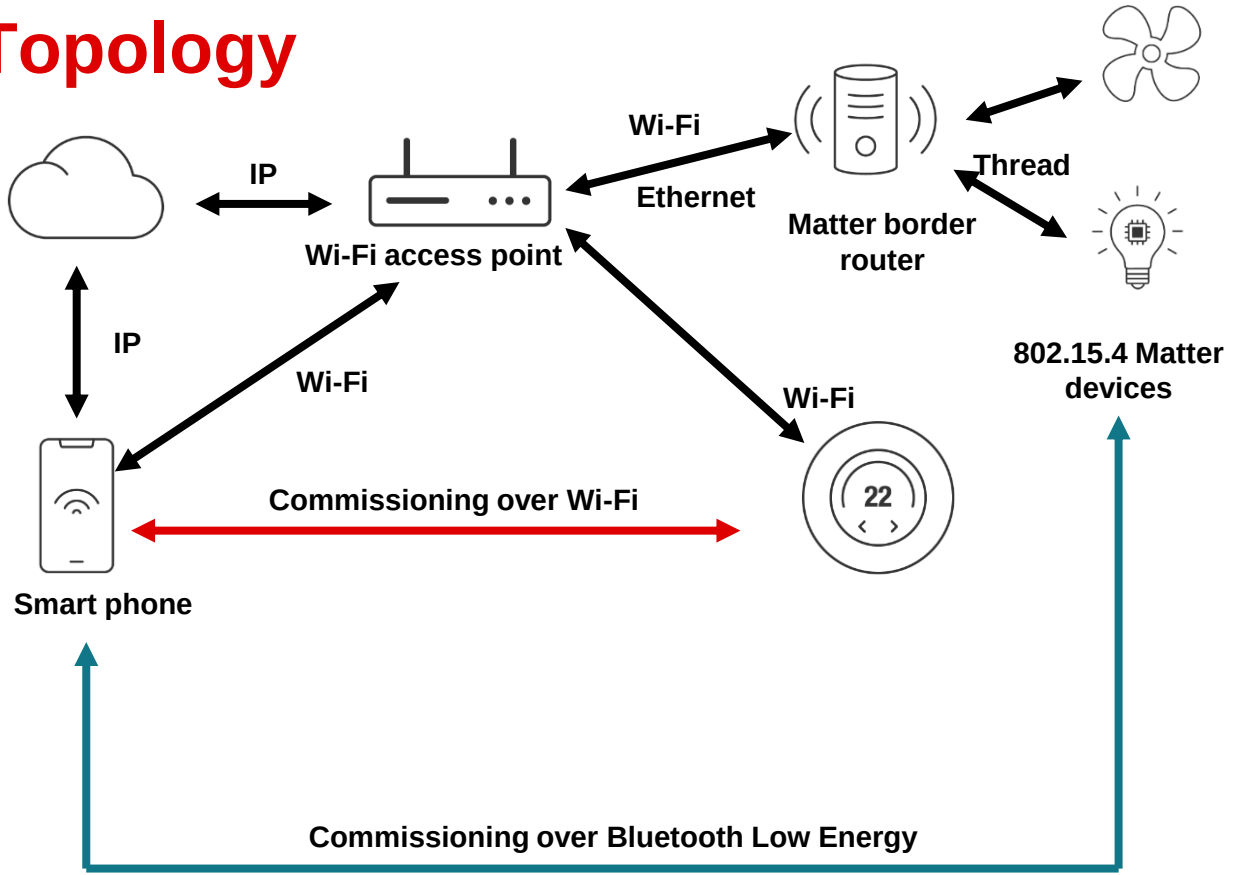
Ultra-Low-Power | Designed to be in standby and active when needed. CSA works closely with silicon vendors to design next generation wireless MCUs with ultra-low standby current consumption.

Faster time to market | Leverage open source technology. Supported by more than 500 members in the alliance. Matter-certified products are interoperable.

Matter Network Topology

Matter is an application layer protocol that runs on the “Application” layer of Thread or Wi-Fi





Why choose TI for the Matter protocol?

Industry leadership

TI has been a CSA board member for 10 years and participated in the development of Matter. We are a contributor member to the Thread Group, are a Wi-Fi Alliance member and have 20+ years of connectivity experience.

Flexible portfolio

Select from a broad portfolio of wireless radios for 2.4 GHz, Sub-1 GHz and Wi-Fi connectivity. Choose the right protocol and features to drive innovation within your connectivity solution.

Get started today with CC2652x7 and CC3235SF

Industry's lowest power

Extend your battery life with our Thread and Matter devices with features including 0.85-µA standby current over temperature, best-in-class coin-cell operation at 10 dBm and more.

Integrated security features

Featuring 30+ security enablers and a multilayer security approach for Wi-Fi connectivity, our SimpleLink MCUs help you protect data and combat against cyber-security attacks.

TI Matter | Device Support

	Device	Flash SRAM	Matter device roles	Other features	Production Date
Thread	**CC2651x3**	352kB 32kB (+8kB no cache)	• Thread RCP		In production
	CC2340R5	512kB 36kB	• Thread RCP		MP Q1 2023
	CC2652x	352kB (+256kB ROM) 80kB (+8kB no cache)	• Thread NCP (FTD or MTD) • Thread RCP	• Concurrent BLE	In production
	CC2652x7	704kB (+256kB ROM) 144kB (+8kB no cache)	• **SoC - Matter + Thread FTD** • **SoC - Matter + Thread MTD** • Thread RCP or Thread NCP	• Concurrent BLE	In production
Wi-Fi	**CC3230SF**	256kB 1MB XIP	• Wi-Fi SoC + Matter	• 2.4GHz Wi-Fi • 1-Wire Coex to BLE	In production
	CC3235SF	256kB 1MB XIP	• Wi-Fi SoC + Matter	• 2.4 & 5GHz Wi-Fi • 1-Wire Coex to BLE	In production

Go to www.ti.com/Matter to learn more

Questions?

Visit www.ti.com/npu

For more information on the New Product Update series, calendar and archived recordings

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